
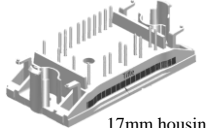
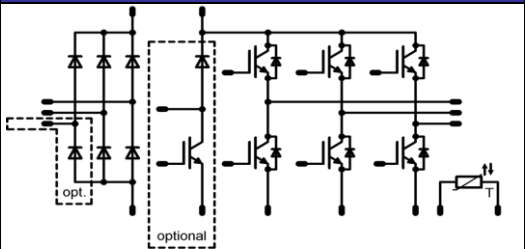


| flowPIM 0 | 600V/30A |
|---|---|
| <div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #000080; color: white; margin: 0;">Features</p> <ul style="list-style-type: none"> Vincotech clip-in housing Trench Fieldstop IGBT's for low saturation losses Optional w/o BRC </div> <div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #000080; color: white; margin: 0;">Target Applications</p> <ul style="list-style-type: none"> Industrial drives Embedded drives </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #000080; color: white; margin: 0;">Types</p> <ul style="list-style-type: none"> V23990-P546-A38-PM V23990-P546-A39-PM V23990-P546-C38-PM V23990-P546-C39-PM </div> | <div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #000080; color: white; margin: 0;">flowPIM 0 housing</p> <div style="display: flex; justify-content: space-around; align-items: center;"> <div style="text-align: center;">  <p>12mm housing</p> </div> <div style="text-align: center;">  <p>17mm housing</p> </div> </div> </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #000080; color: white; margin: 0;">Schematic</p>  </div> |

Maximum Ratings

$T_j=25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Condition | Value | Unit | |
|--------------------------------------|--------------|---|------------------------|----------------------|---|
| Input Rectifier Diode | | | | | |
| Repetitive peak reverse voltage | V_{RRM} | | 1600 | V | |
| DC forward current | I_{FAV} | $T_j=T_{jmax}$ | $T_h=80^\circ\text{C}$ | 33 | A |
| | | | $T_c=80^\circ\text{C}$ | 46 | |
| Surge forward current | I_{FSM} | $t_p=10\text{ms}$ | 250 | A | |
| I2t-value | I^2t | 50Hz half sine wave | 310 | A^2s | |
| Power dissipation per Diode | P_{tot} | $T_j=T_{jmax}$ | $T_h=80^\circ\text{C}$ | 37 | W |
| | | | $T_c=80^\circ\text{C}$ | 59 | |
| Maximum Junction Temperature | T_{jmax} | | 150 | $^\circ\text{C}$ | |
| Inverter Transistor | | | | | |
| Collector-emitter break down voltage | V_{CE} | | 600 | V | |
| DC collector current | I_C | $T_j=T_{jmax}$ | $T_h=80^\circ\text{C}$ | 27 | A |
| | | | $T_c=80^\circ\text{C}$ | 36 | |
| Repetitive peak collector current | I_{Cpulse} | t_p limited by T_{jmax} | 90 | A | |
| Turn off safe operating area | | $V_{CE} \leq 600\text{V}$, $T_j \leq T_{op max}$ | 90 | A | |
| Power dissipation per IGBT | P_{tot} | $T_j=T_{jmax}$ | $T_h=80^\circ\text{C}$ | 54 | W |
| | | | $T_c=80^\circ\text{C}$ | 82 | |
| Gate-emitter peak voltage | V_{GE} | | ± 20 | V | |
| Short circuit ratings | t_{SC} | $T_j \leq 150^\circ\text{C}$ | 6 | μs | |
| | V_{CC} | $V_{GE}=15\text{V}$ | 360 | V | |
| Maximum Junction Temperature | T_{jmax} | | 175 | $^\circ\text{C}$ | |

Maximum Ratings

 $T_j=25^{\circ}\text{C}$, unless otherwise specified

| Parameter | Symbol | Condition | Value | Unit |
|---------------------------------|------------|--|----------|--------------------|
| Inverter Diode | | | | |
| Peak Repetitive Reverse Voltage | V_{RRM} | | 600 | V |
| DC forward current | I_F | $T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$ | 25 32 | A |
| Repetitive peak forward current | I_{FRM} | t_p limited by T_{jmax} | 60 | A |
| Power dissipation per Diode | P_{tot} | $T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$ | 40 60 | W |
| Maximum Junction Temperature | T_{jmax} | | 175 | $^{\circ}\text{C}$ |

Brake Transistor

| | | | | |
|--------------------------------------|----------------------|--|----------|--------------------|
| Collector-emitter break down voltage | V_{CE} | | 600 | V |
| DC collector current | I_C | $T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$ | 21 27 | A |
| Repetitive peak collector current | I_{Cpuls} | t_p limited by T_{jmax} | 60 | A |
| Turn off safe operating area | | $V_{CE} \leq 600V, T_j \leq T_{jmax}$ | 60 | A |
| Power dissipation per IGBT | P_{tot} | $T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$ | 41 63 | W |
| Gate-emitter peak voltage | V_{GE} | | ± 20 | V |
| Short circuit ratings | t_{SC} V_{CC} | $T_j \leq 150^{\circ}\text{C}$ $V_{GE} = 15V$ | 6 360 | μs V |
| Maximum Junction Temperature | T_{jmax} | | 175 | $^{\circ}\text{C}$ |

Brake Diode

| | | | | |
|---------------------------------|------------|--|----------|--------------------|
| Peak Repetitive Reverse Voltage | V_{RRM} | | 600 | V |
| DC forward current | I_F | $T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$ | 18 25 | A |
| Repetitive peak forward current | I_{FRM} | t_p limited by T_{jmax} | 40 | A |
| Power dissipation per Diode | P_{tot} | $T_j=T_{jmax}$ $T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$ | 31 47 | W |
| Maximum Junction Temperature | T_{jmax} | | 175 | $^{\circ}\text{C}$ |

Thermal Properties

| | | | | |
|---|-----------|--|----------------------------|--------------------|
| Storage temperature | T_{stg} | | -40...+125 | $^{\circ}\text{C}$ |
| Operation temperature under switching condition | T_{op} | | -40...+($T_{jmax} - 25$) | $^{\circ}\text{C}$ |

Insulation Properties

| | | | | |
|----------------------------|----------|-------------------|----------|----|
| Insulation voltage | V_{is} | $t=2s$ DC voltage | 4000 | V |
| Creepage distance | | | min 12,7 | mm |
| Clearance | | | min 12,7 | mm |
| Comparative tracking index | CTI | | >200 | |

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Value | | | Unit |
|---|-----------------|--|--|----------------------------------|---|---|--------------|--------|-----|------------------|
| | | $V_{GE}[V]$ or $V_{GS}[V]$ | $V_i[V]$ or $V_{CE}[V]$ or $V_{DS}[V]$ | $I_c[A]$ or $I_F[A]$ or $I_b[A]$ | T_j | Min | Typ | Max | | |
| Input Rectifier Diode | | | | | | | | | | |
| Forward voltage | V_F | | | 30 | $T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$ | 0,8 | 1,16 1,13 | 1,6 | | V |
| Threshold voltage (for power loss calc. only) | V_{to} | | | 30 | $T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$ | | 0,90 0,78 | | | V |
| Slope resistance (for power loss calc. only) | r_t | | | 30 | $T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$ | | 8 11 | | | m Ω |
| Reverse current | I_r | | 1500 | | $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ | | | 2 | | mA |
| Thermal resistance chip to heatsink per chip | R_{thJH} | Thermal grease thickness \leq 50um $\lambda = 1$ W/mK | | | | | 1,89 | | | K/W |
| Inverter Transistor | | | | | | | | | | |
| Gate emitter threshold voltage | $V_{GE(th)}$ | $V_{CE}=V_{GE}$ | | 0,00043 | $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ | 5 | 5,8 | 6,5 | | V |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | | 15 | 50 | $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ | 1,1 | 1,67 1,90 | 1,9 | | V |
| Collector-emitter cut-off current incl. Diode | I_{CES} | | 0 | 600 | $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ | | | 0,0016 | | mA |
| Gate-emitter leakage current | I_{GES} | | 20 | 0 | $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ | | | 300 | | nA |
| Integrated Gate resistor | R_{gint} | | | | | | none | | | Ω |
| Turn-on delay time | $t_{d(on)}$ | Rgoff=4 Ω Rgon=8 Ω | ± 15 | 300 | 30 | $T_j=25^\circ\text{C}$ | 17 | | ns | |
| Rise time | t_r | | | | | $T_i=150^\circ\text{C}$ | 18 | | | |
| Turn-off delay time | $t_{d(off)}$ | | | | | $T_j=25^\circ\text{C}$ | 16 | | | |
| Fall time | t_f | | | | | $T_j=150^\circ\text{C}$ | 18 | | | |
| Turn-on energy loss per pulse | E_{on} | | | | | $T_j=25^\circ\text{C}$ | 156 | | | |
| Turn-off energy loss per pulse | E_{off} | | | | | $T_j=150^\circ\text{C}$ | 172 | | | |
| Turn-on energy loss per pulse | E_{on} | | | | $T_j=25^\circ\text{C}$ | | 88 | | mWs | |
| Turn-off energy loss per pulse | E_{off} | | | | $T_j=150^\circ\text{C}$ | | 101 | | | |
| Input capacitance | C_{ies} | | | | | | 1630 | | pF | |
| Output capacitance | C_{oss} | f=1MHz | 0 | 25 | $T_j=25^\circ\text{C}$ | | 108 | | | |
| Reverse transfer capacitance | C_{rss} | | | | | | 50 | | | |
| Gate charge | Q_{Gate} | | ± 15 | 480 | 30 | $T_j=25^\circ\text{C}$ | | 167 | | nC |
| Thermal resistance chip to heatsink per chip | R_{thJH} | Thermal grease thickness \leq 50um $\lambda = 1$ W/mK | | | | | 1,76 | | | K/W |
| Inverter Diode | | | | | | | | | | |
| Diode forward voltage | V_F | | | 30 | $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ | 1,25 | 1,64 1,66 | 1,95 | | V |
| Peak reverse recovery current | I_{RRM} | | | | $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ | | 25 28 | | | A |
| Reverse recovery time | t_{rr} | | | | $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ | | 176 256 | | | ns |
| Reverse recovered charge | Q_{rr} | Rgon=8 Ω | ± 15 | 300 | 30 | $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ | 1,36 2,45 | | | μC |
| Peak rate of fall of recovery current | $di(rec)max/dt$ | | | | | $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ | 1521 932 | | | A/ μs |
| Reverse recovered energy | E_{rec} | | | | | $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ | 0,27 0,51 | | | mWs |
| Thermal resistance chip to heatsink per chip | R_{thJH} | Thermal grease thickness \leq 50um $\lambda = 1$ W/mK | | | | | 2,40 | | | K/W |

Characteristic Values

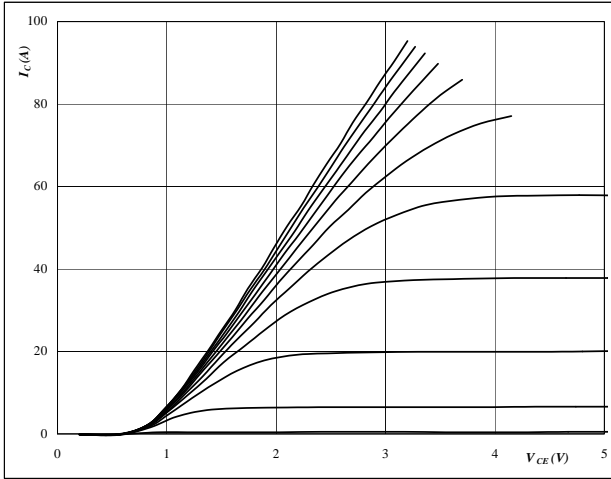
| Parameter | Symbol | Conditions | | | | | Value | | | Unit |
|--|-----------------|---|--|----------------------------------|---------|---------------------------------------|-------|--------------|--------|----------|
| | | $V_{GE}[V]$ or $V_{GS}[V]$ | $V_i[V]$ or $V_{CE}[V]$ or $V_{DS}[V]$ | $I_c[A]$ or $I_F[A]$ or $I_b[A]$ | T_j | Min | Typ | Max | | |
| Brake Transistor | | | | | | | | | | |
| Gate emitter threshold voltage | $V_{GE(th)}$ | $V_{CE}=V_{GE}$ | | | 0,00029 | $T_j=25^\circ C$ $T_j=150^\circ C$ | 5 | 5,8 | 6,5 | V |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | | 15 | | 20 | $T_j=25^\circ C$ $T_j=150^\circ C$ | 1 | 1,58 1,76 | 2,2 | V |
| Collector-emitter cut-off incl diode | I_{CES} | | 0 | 600 | | $T_j=25^\circ C$ $T_j=150^\circ C$ | | | 0,0011 | mA |
| Gate-emitter leakage current | I_{GES} | | 20 | 0 | | $T_j=25^\circ C$ $T_j=150^\circ C$ | | | 300 | nA |
| Integrated Gate resistor | R_{gint} | | | | | | | none | | Ω |
| Turn-on delay time | $t_{d(on)}$ | $R_{goff}=8 \Omega$ $R_{gon}=16 \Omega$ | ± 15 | 300 | 20 | $T_j=25^\circ C$ | | 15 | | ns |
| Rise time | t_r | | | | | $T_j=150^\circ C$ | | 14 | | |
| Turn-off delay time | $t_{d(off)}$ | | | | | $T_j=25^\circ C$ | | 12 | | |
| | | | | | | $T_j=150^\circ C$ | | 15 | | |
| Fall time | t_f | | | | | $T_j=25^\circ C$ | | 197 | | |
| | | | | | | $T_j=150^\circ C$ | | 220 | | |
| Turn-on energy loss per pulse | E_{on} | | | | | $T_j=25^\circ C$ $T_j=150^\circ C$ | | 0,31 0,43 | | mWs |
| Turn-off energy loss per pulse | E_{off} | | | | | $T_j=25^\circ C$ $T_j=150^\circ C$ | | 0,53 0,67 | | |
| Input capacitance | C_{ies} | f=1MHz | 0 | 25 | | $T_j=25^\circ C$ | | 1100 | | pF |
| Output capacitance | C_{oss} | | | | | | | 71 | | |
| Reverse transfer capacitance | C_{rss} | | | | | | | 32 | | |
| Gate charge | Q_{Gate} | | ± 15 | 480 | 20 | $T_j=25^\circ C$ | | 120 | | nC |
| Thermal resistance chip to heatsink per chip | R_{thJH} | Thermal grease thickness $\leq 50\mu m$ $\lambda = 1 W/mK$ | | | | | | 2,30 | | K/W |
| Brake Diode | | | | | | | | | | |
| Diode forward voltage | V_F | | | | 20 | $T_j=25^\circ C$ $T_j=150^\circ C$ | 1,25 | 1,83 1,76 | 1,95 | V |
| Reverse leakage current | I_r | $R_{gon}=16 \Omega$ | | 300 | | $T_j=25^\circ C$ $T_j=150^\circ C$ | | | 27 | μA |
| Peak reverse recovery current | I_{RRM} | $R_{gon}=16 \Omega$ | ± 15 | 300 | 20 | $T_j=25^\circ C$ | | 18 | | A |
| Reverse recovery time | t_{rr} | | | | | $T_j=150^\circ C$ | | 21 | | |
| | | | | | | $T_j=25^\circ C$ | | 31 | | |
| Reverse recovered charge | Q_{rr} | | | | | $T_j=150^\circ C$ | | 197 | | |
| | | | | | | $T_j=25^\circ C$ | | 0,39 | | |
| Peak rate of fall of recovery current | $di(rec)max/dt$ | | | | | $T_j=150^\circ C$ | | 0,39 | | |
| | | $T_j=25^\circ C$ | | 1762 | | | | | | |
| Reverse recovery energy | E_{rec} | | | | | $T_j=25^\circ C$ $T_j=150^\circ C$ | | 0,05 0,25 | | mWs |
| Thermal resistance chip to heatsink per chip | R_{thJH} | Thermal grease thickness $\leq 50\mu m$ $\lambda = 1 W/mK$ | | | | | | 3,04 | | K/W |
| Thermistor | | | | | | | | | | |
| Rated resistance | R | | | | | $T_j=25^\circ C$ | | 22000 | | Ω |
| Deviation of R100 | $\Delta R/R$ | R100=1486 Ω | | | | $T_c=100^\circ C$ | -5 | | 5 | % |
| Power dissipation | P | | | | | $T_c=100^\circ C$ | | 210 | | mW |
| Power dissipation constant | | | | | | $T_j=25^\circ C$ | | 3,5 | | mW/K |
| B-value | $B_{(25/50)}$ | Tol. $\pm 3\%$ | | | | $T_j=25^\circ C$ | | | | K |
| B-value | $B_{(25/100)}$ | Tol. $\pm 3\%$ | | | | $T_j=25^\circ C$ | | 4000 | | K |
| Vincotech NTC Reference | | | | | | $T_j=25^\circ C$ | | | A | |

Output Inverter

Figure 1 Output inverter IGBT

Typical output characteristics

$I_C = f(V_{CE})$

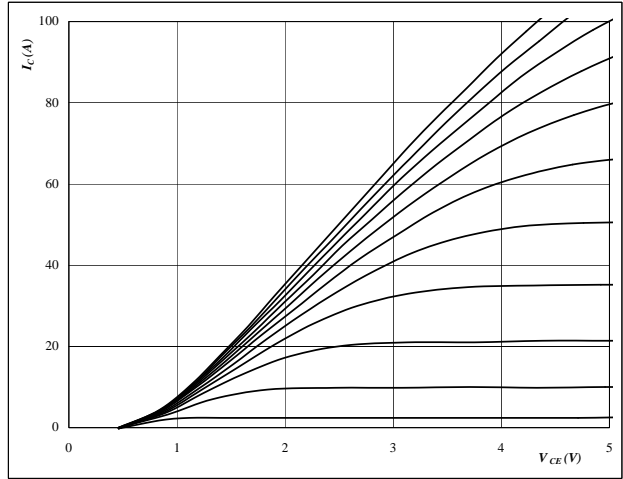


At
 $t_p = 250 \mu s$
 $T_j = 25 \text{ }^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

Figure 2 Output inverter IGBT

Typical output characteristics

$I_C = f(V_{CE})$

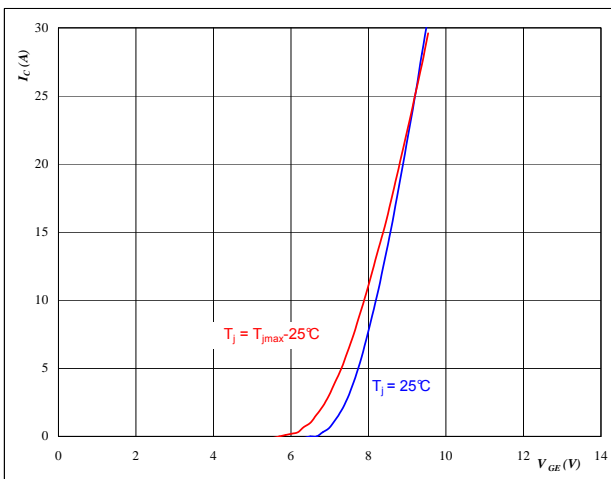


At
 $t_p = 250 \mu s$
 $T_j = 125 \text{ }^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

Figure 3 Output inverter IGBT

Typical transfer characteristics

$I_C = f(V_{GE})$

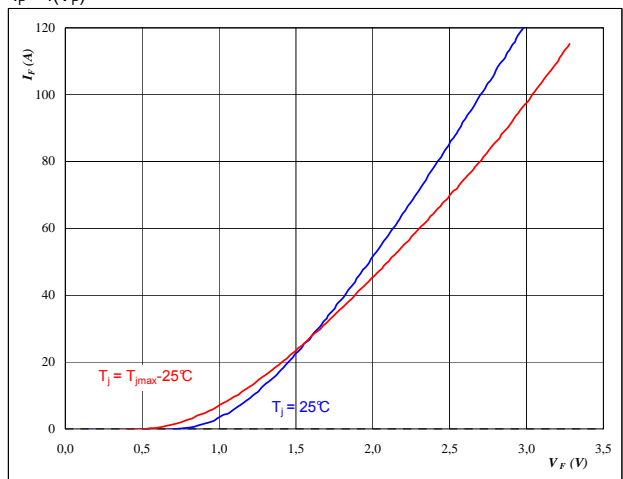


At
 $t_p = 250 \mu s$
 $V_{CE} = 10 V$

Figure 4 Output inverter FWD

Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$

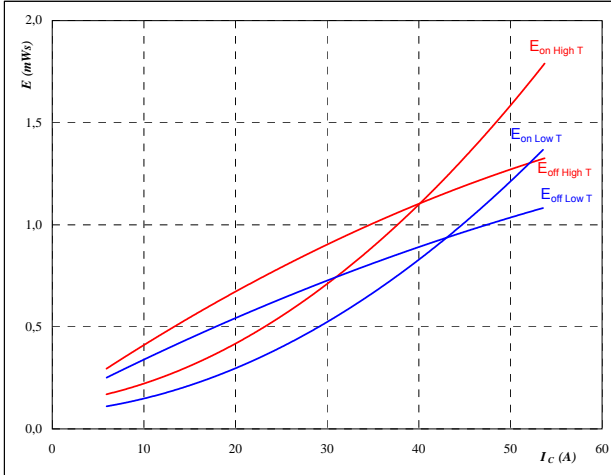


At
 $t_p = 250 \mu s$

Output Inverter

Figure 5 Output inverter IGBT

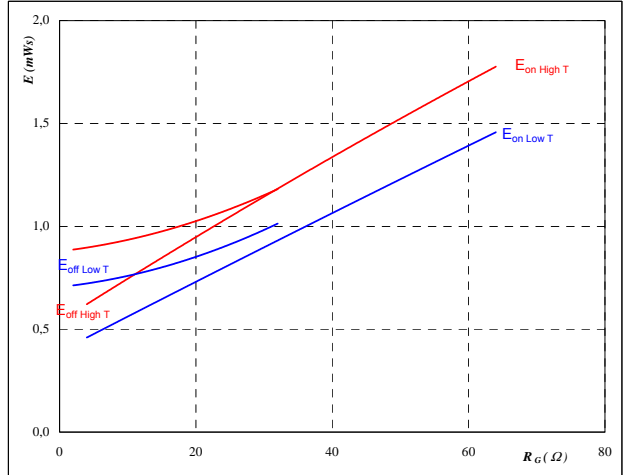
Typical switching energy losses
as a function of collector current
 $E = f(I_C)$



With an inductive load at
 $T_j = 25/125$ °C
 $V_{CE} = 300$ V
 $V_{GE} = 15$ V
 $R_{gon} = 8$ Ω
 $R_{goff} = 4$ Ω

Figure 6 Output inverter IGBT

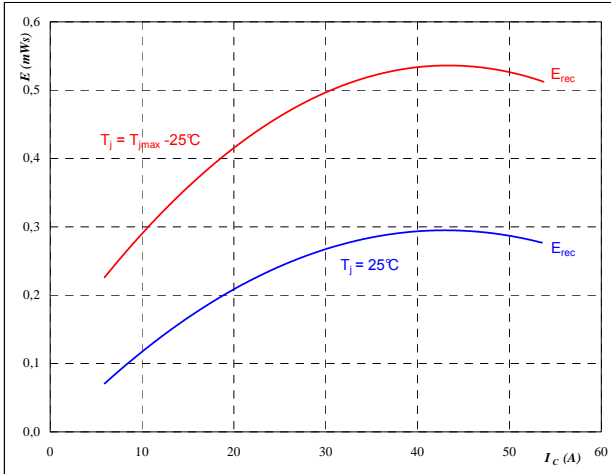
Typical switching energy losses
as a function of gate resistor
 $E = f(R_G)$



With an inductive load at
 $T_j = 25/125$ °C
 $V_{CE} = 300$ V
 $V_{GE} = 15$ V
 $I_C = 30$ A

Figure 7 Output inverter FWD

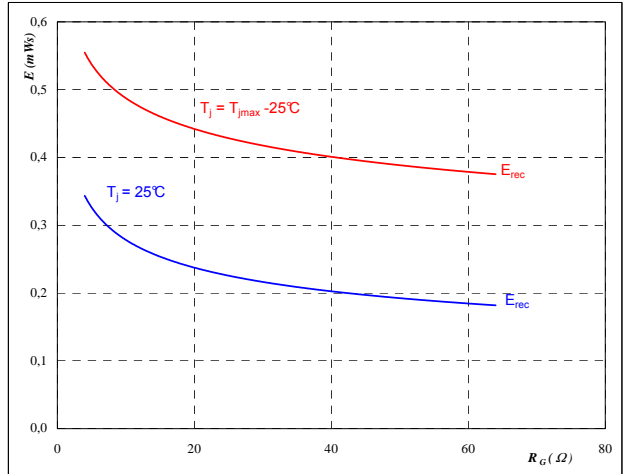
Typical reverse recovery energy loss
as a function of collector current
 $E_{rec} = f(I_C)$



With an inductive load at
 $T_j = 25/125$ °C
 $V_{CE} = 300$ V
 $V_{GE} = 15$ V
 $R_{gon} = 8$ Ω

Figure 8 Output inverter FWD

Typical reverse recovery energy loss
as a function of gate resistor
 $E_{rec} = f(R_G)$



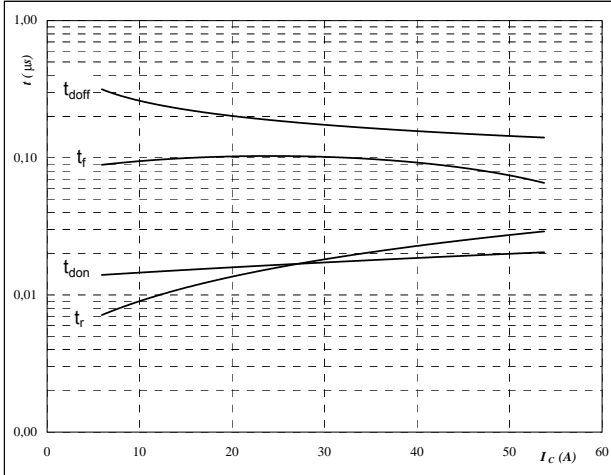
With an inductive load at
 $T_j = 25/125$ °C
 $V_{CE} = 300$ V
 $V_{GE} = 15$ V
 $I_C = 30$ A

Output Inverter

Figure 9 Output inverter IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



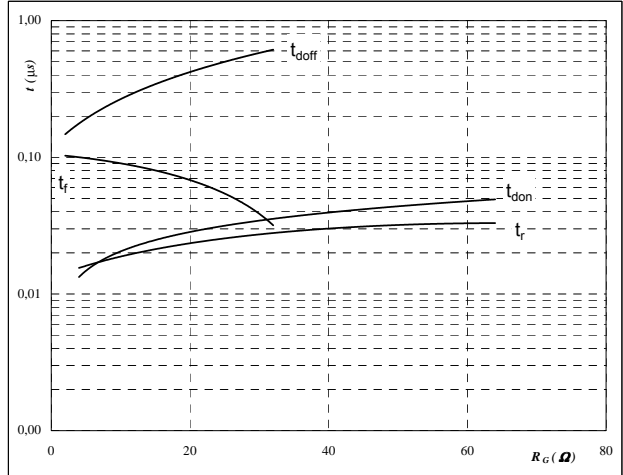
With an inductive load at

| | | |
|--------------|-----|----|
| $T_j =$ | 125 | °C |
| $V_{CE} =$ | 300 | V |
| $V_{GE} =$ | 15 | V |
| $R_{gon} =$ | 8 | Ω |
| $R_{goff} =$ | 4 | Ω |

Figure 10 Output inverter IGBT

Typical switching times as a function of gate resistor

$$t = f(R_G)$$



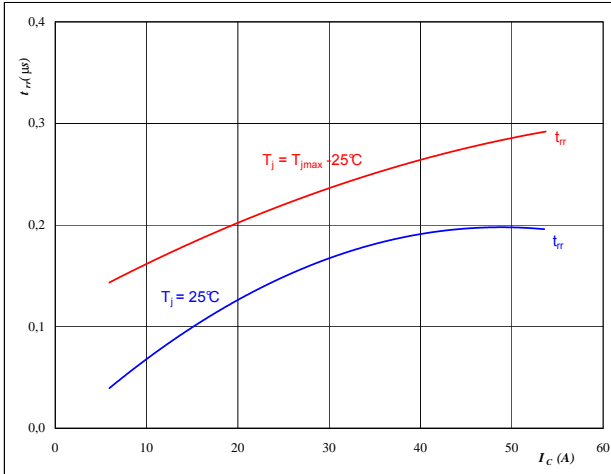
With an inductive load at

| | | |
|------------|-----|----|
| $T_j =$ | 125 | °C |
| $V_{CE} =$ | 300 | V |
| $V_{GE} =$ | 15 | V |
| $I_C =$ | 30 | A |

Figure 11 Output inverter FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



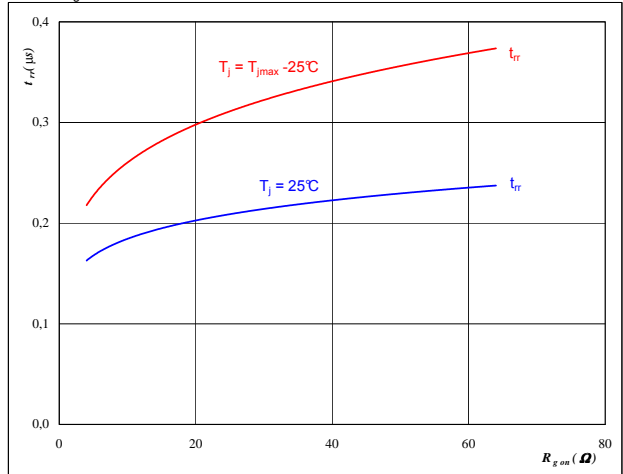
At

| | | |
|-------------|--------|----|
| $T_j =$ | 25/125 | °C |
| $V_{CE} =$ | 300 | V |
| $V_{GE} =$ | 15 | V |
| $R_{gon} =$ | 8 | Ω |

Figure 12 Output inverter FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At

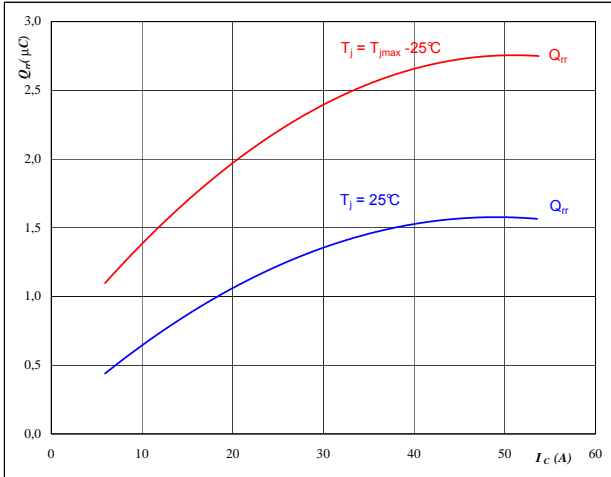
| | | |
|------------|--------|----|
| $T_j =$ | 25/125 | °C |
| $V_R =$ | 300 | V |
| $I_F =$ | 30 | A |
| $V_{GE} =$ | 15 | V |

Output Inverter

Figure 13 Output inverter FWD

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_C)$$

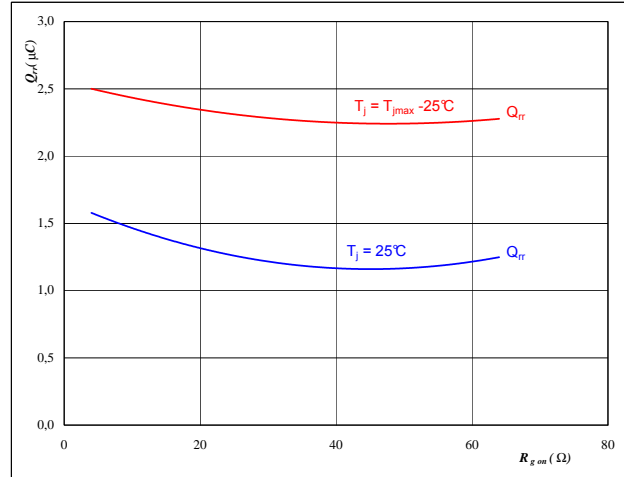


At
 $T_j = 25/125$ °C
 $V_{CE} = 300$ V
 $V_{GE} = 15$ V
 $R_{gon} = 8$ Ω

Figure 14 Output inverter FWD

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$

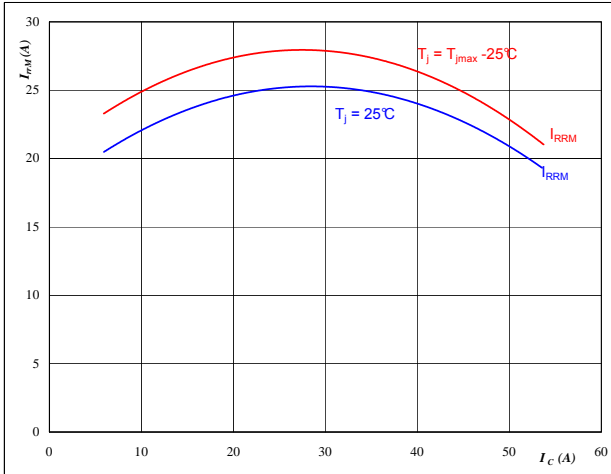


At
 $T_j = 25/125$ °C
 $V_R = 300$ V
 $I_F = 30$ A
 $V_{GE} = 15$ V

Figure 15 Output inverter FWD

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_C)$$

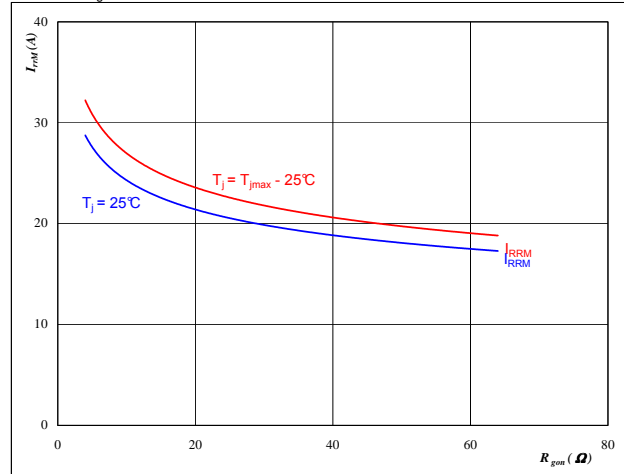


At
 $T_j = 25/125$ °C
 $V_{CE} = 300$ V
 $V_{GE} = 15$ V
 $R_{gon} = 8$ Ω

Figure 16 Output inverter FWD

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$



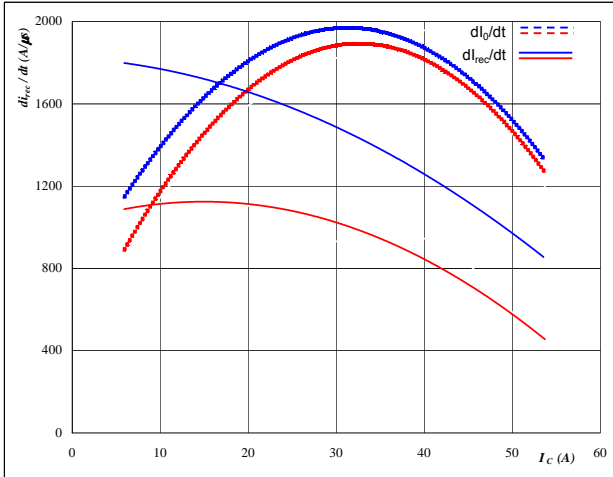
At
 $T_j = 25/125$ °C
 $V_R = 300$ V
 $I_F = 30$ A
 $V_{GE} = 15$ V

Output Inverter

Figure 17 Output inverter FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$$di_f/dt, di_{rec}/dt = f(I_C)$$

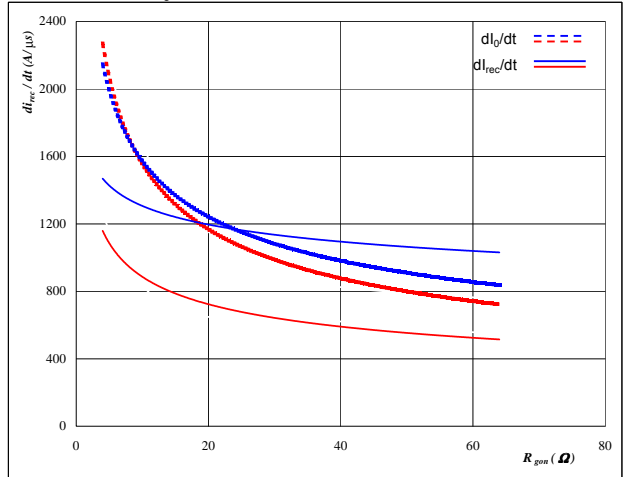


At
 $T_j = 25/125$ °C
 $V_{CE} = 300$ V
 $V_{GE} = 15$ V
 $R_{gon} = 8$ Ω

Figure 18 Output inverter FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$$di_f/dt, di_{rec}/dt = f(R_{gon})$$

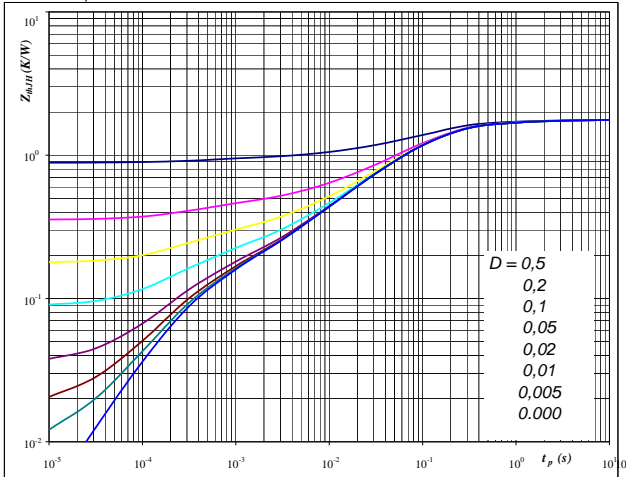


At
 $T_j = 25/125$ °C
 $V_R = 300$ V
 $I_F = 30$ A
 $V_{GE} = 15$ V

Figure 19 Output inverter IGBT

IGBT transient thermal impedance as a function of pulse width

$$Z_{th,JH} = f(t_p)$$



At
 $D = t_p / T$
 $R_{th,JH} = 1,76$ K/W 1,43

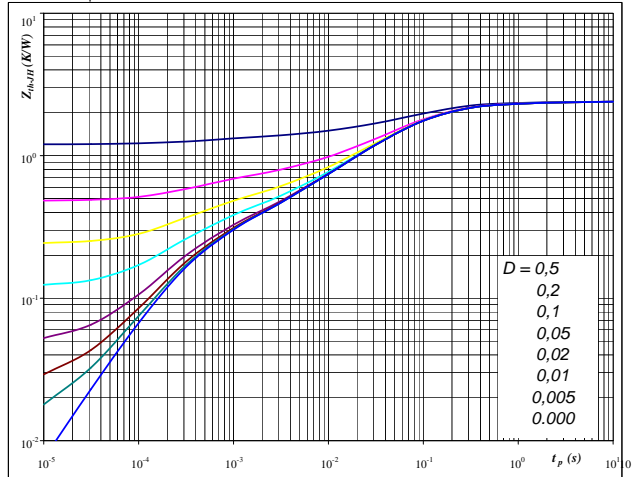
IGBT thermal model values

| Thermal grease | | Phase change interface | |
|----------------|---------|------------------------|---------|
| R (C/W) | Tau (s) | R (C/W) | Tau (s) |
| 0,06 | 4,6E+00 | 0,05 | 3,7E+00 |
| 0,22 | 5,4E-01 | 0,17 | 4,3E-01 |
| 0,94 | 1,0E-01 | 0,76 | 8,4E-02 |
| 0,34 | 2,0E-02 | 0,27 | 1,6E-02 |
| 0,11 | 3,1E-03 | 0,09 | 2,5E-03 |
| 0,11 | 3,0E-04 | 0,09 | 2,4E-04 |

Figure 20 Output inverter FWD

FWD transient thermal impedance as a function of pulse width

$$Z_{th,JH} = f(t_p)$$



At
 $D = t_p / T$
 $R_{th,JH} = 2,40$ K/W 1,94

FWD thermal model values

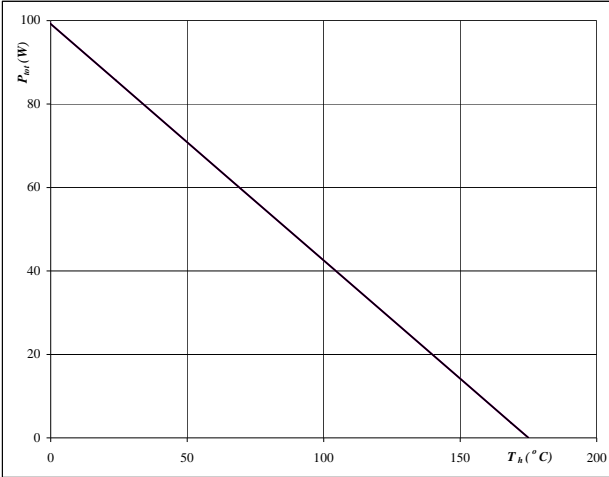
| Thermal grease | | Phase change interface | |
|----------------|---------|------------------------|---------|
| R (C/W) | Tau (s) | R (C/W) | Tau (s) |
| 0,07 | 4,6E+00 | 0,06 | 3,7E+00 |
| 0,27 | 4,8E-01 | 0,22 | 3,9E-01 |
| 1,13 | 8,5E-02 | 0,92 | 6,9E-02 |
| 0,52 | 2,0E-02 | 0,42 | 1,6E-02 |
| 0,20 | 2,8E-03 | 0,16 | 2,3E-03 |
| 0,21 | 3,3E-04 | 0,17 | 2,7E-04 |

Output Inverter

Figure 21 Output inverter IGBT

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_h)$$

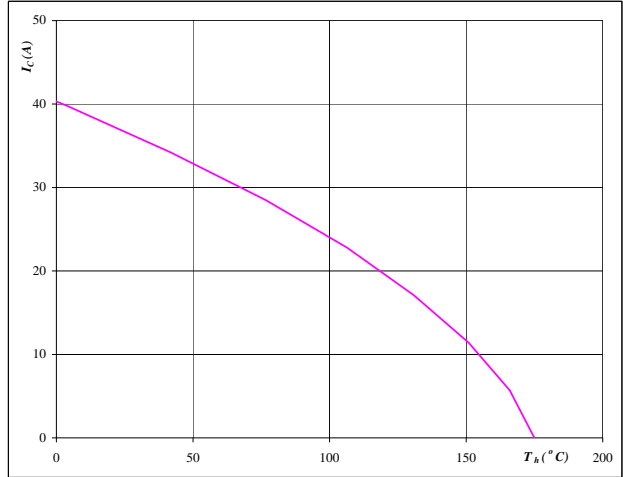


At $T_j = 175$ °C

Figure 22 Output inverter IGBT

Collector current as a function of heatsink temperature

$$I_C = f(T_h)$$

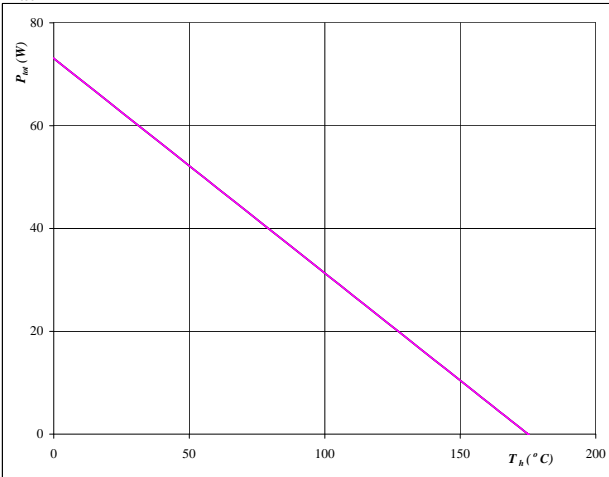


At $T_j = 175$ °C
 $V_{GE} = 15$ V

Figure 23 Output inverter FWD

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_h)$$

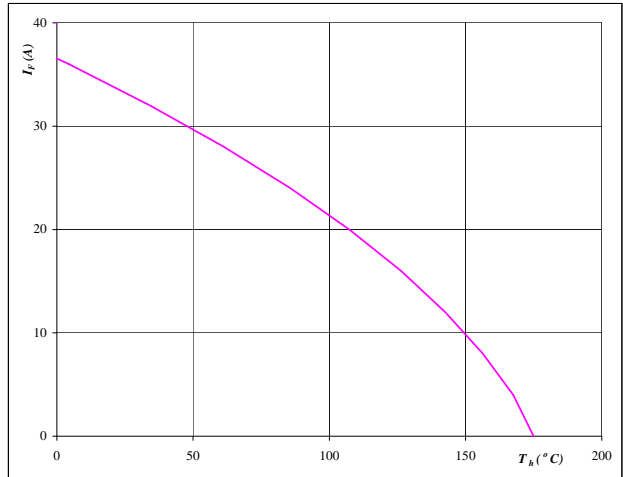


At $T_j = 175$ °C

Figure 24 Output inverter FWD

Forward current as a function of heatsink temperature

$$I_F = f(T_h)$$



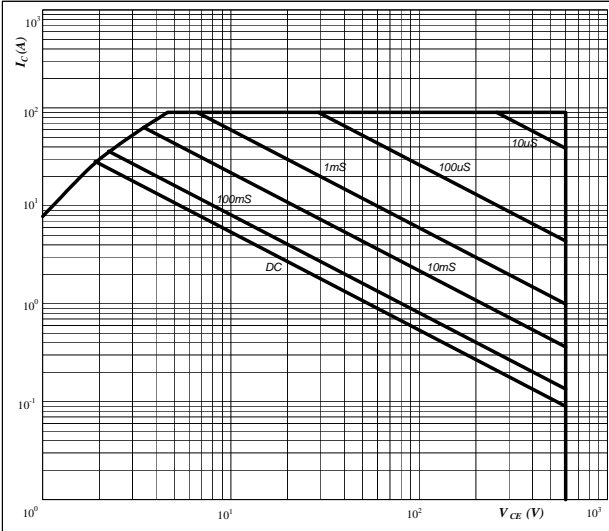
At $T_j = 175$ °C

Output Inverter

Figure 25 Output inverter IGBT

Safe operating area as a function of collector-emitter voltage

$$I_C = f(V_{CE})$$

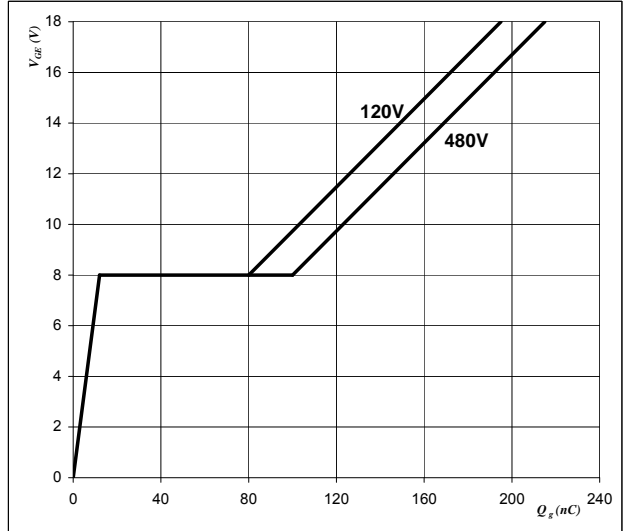


At
 D = single pulse
 $T_n = 80$ °C
 $V_{GE} = 15$ V
 $T_j = T_{jmax}$ °C

Figure 26 Output inverter IGBT

Gate voltage vs Gate charge

$$V_{GE} = f(Q_{GE})$$

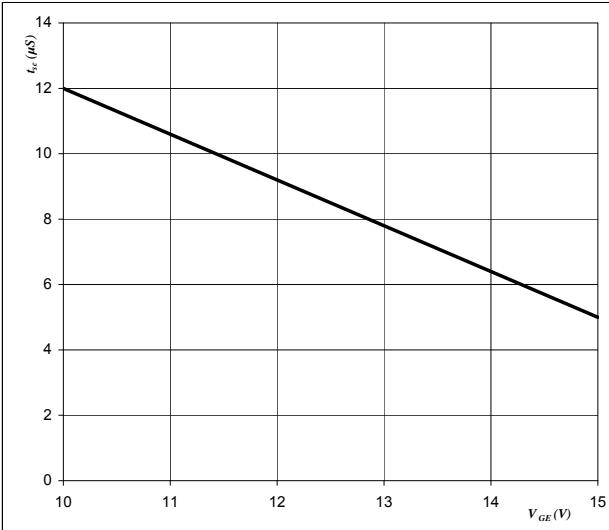


At
 $I_C = 30$ A

Figure 27 Output inverter IGBT

Short circuit withstand time as a function of gate-emitter voltage

$$t_{sc} = f(V_{GE})$$

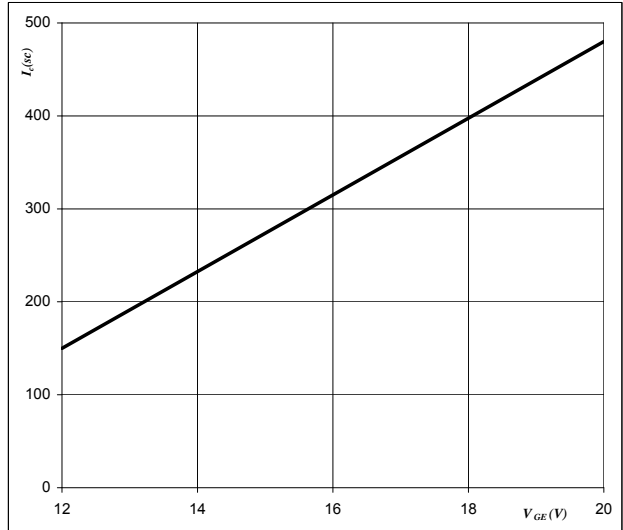


At
 $V_{CE} = 600$ V
 $T_j \leq 175$ °C

Figure 28 Output inverter IGBT

Typical short circuit collector current as a function of gate-emitter voltage

$$V_{GE} = f(Q_{GE})$$

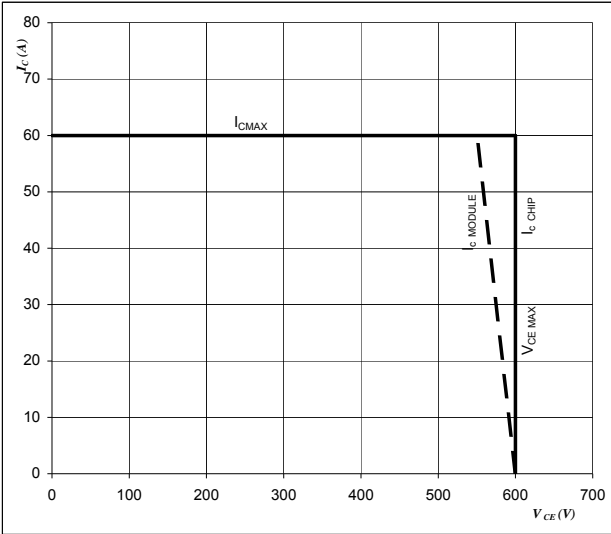


At
 $V_{CE} \leq 600$ V
 $T_j = 175$ °C

Figure 29 IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At

$T_j = T_{j\text{max}} - 25 \text{ } ^\circ\text{C}$

$U_{cc\text{minus}} = U_{cc\text{plus}}$

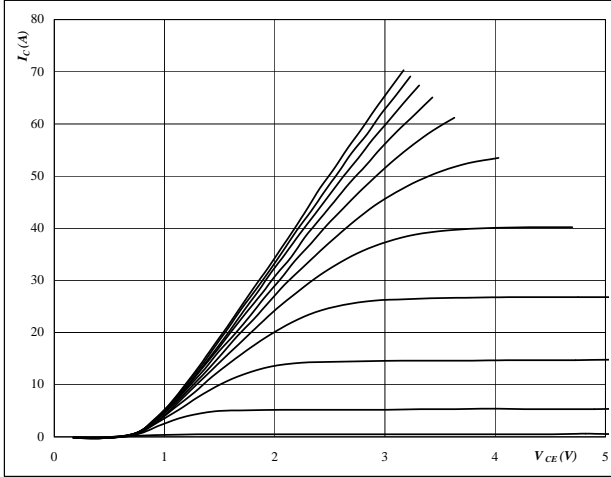
Switching mode : 3phase SPWM

Brake

Figure 1 Brake IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



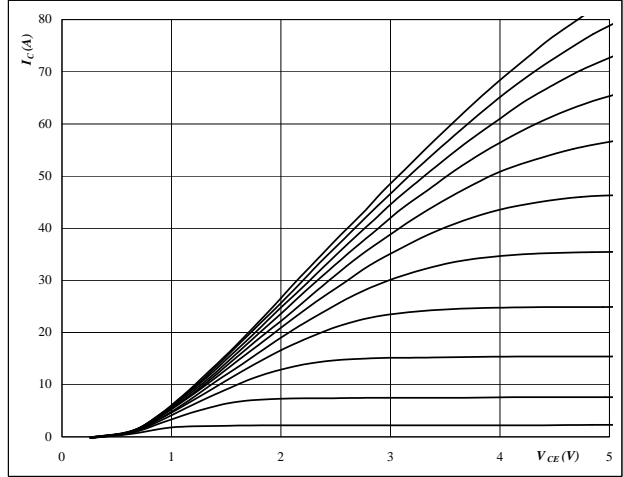
At

$t_p = 250 \mu s$
 $T_j = 25 \text{ }^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

Figure 2 Brake IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



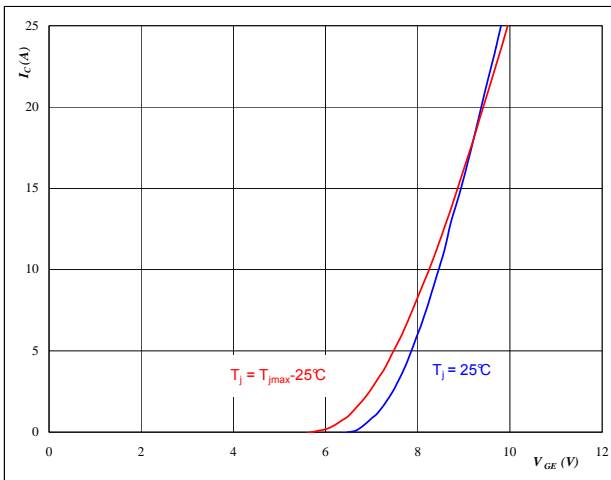
At

$t_p = 250 \mu s$
 $T_j = 125 \text{ }^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

Figure 3 Brake IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$



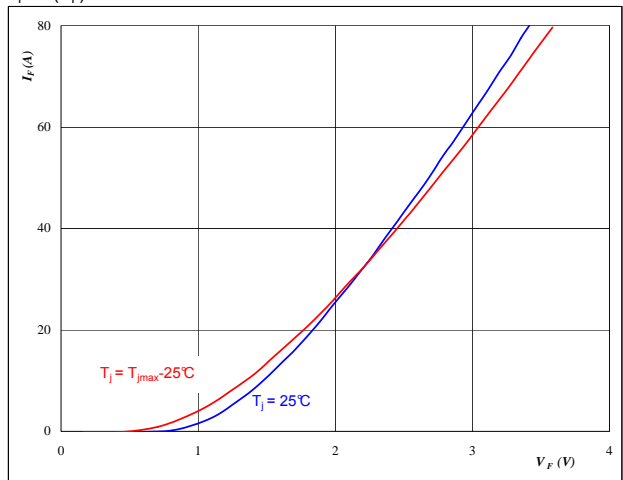
At

$t_p = 250 \mu s$
 $V_{CE} = 10 V$

Figure 4 Brake FWD

Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$



At

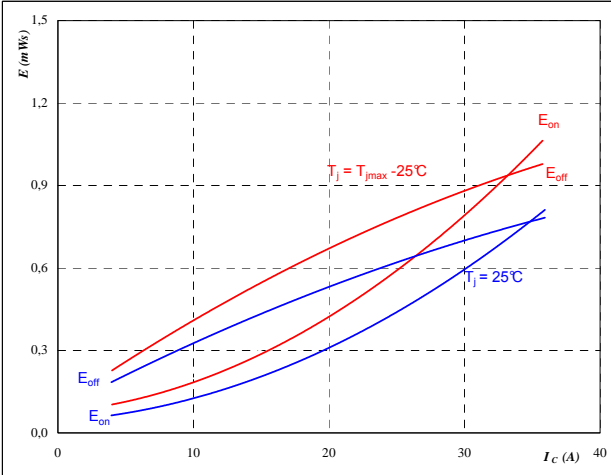
$t_p = 250 \mu s$

Brake

Figure 5 Brake IGBT

Typical switching energy losses
as a function of collector current

$$E = f(I_C)$$



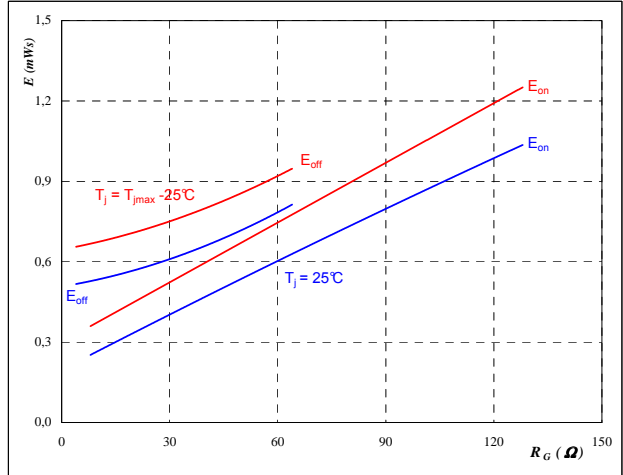
With an inductive load at

| | | |
|--------------|--------|----|
| $T_j =$ | 25/125 | °C |
| $V_{CE} =$ | 300 | V |
| $V_{GE} =$ | 15 | V |
| $R_{gon} =$ | 16 | Ω |
| $R_{goff} =$ | 8 | Ω |

Figure 6 Brake IGBT

Typical switching energy losses
as a function of gate resistor

$$E = f(R_G)$$



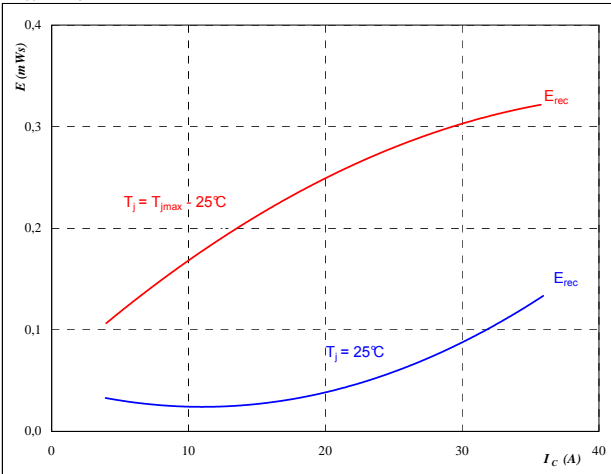
With an inductive load at

| | | |
|------------|--------|----|
| $T_j =$ | 25/125 | °C |
| $V_{CE} =$ | 300 | V |
| $V_{GE} =$ | 15 | V |
| $I_C =$ | 20 | A |

Figure 7 Brake FWD

Typical reverse recovery energy loss
as a function of collector current

$$E_{rec} = f(I_C)$$



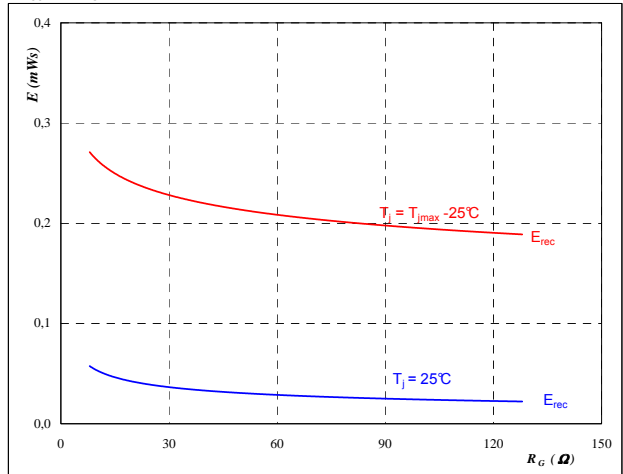
With an inductive load at

| | | |
|-------------|--------|----|
| $T_j =$ | 25/125 | °C |
| $V_{CE} =$ | 300 | V |
| $V_{GE} =$ | 15 | V |
| $R_{gon} =$ | 16 | Ω |

Figure 8 Brake FWD

Typical reverse recovery energy loss
as a function of gate resistor

$$E_{rec} = f(R_G)$$



With an inductive load at

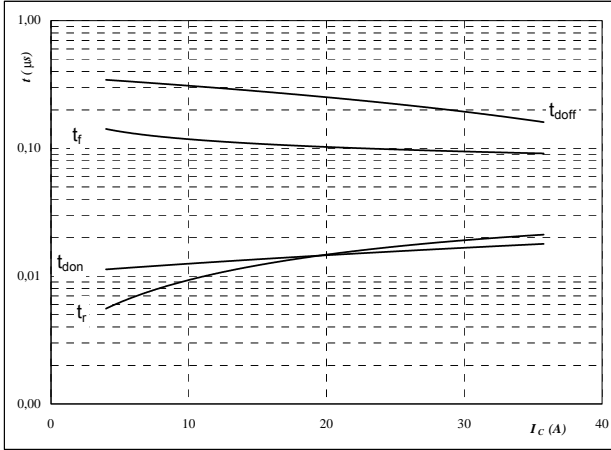
| | | |
|------------|--------|----|
| $T_j =$ | 25/125 | °C |
| $V_{CE} =$ | 300 | V |
| $V_{GE} =$ | 15 | V |
| $I_C =$ | 20 | A |

Brake

Figure 9 Brake IGBT

Typical switching times as a function of collector current

$t = f(I_C)$

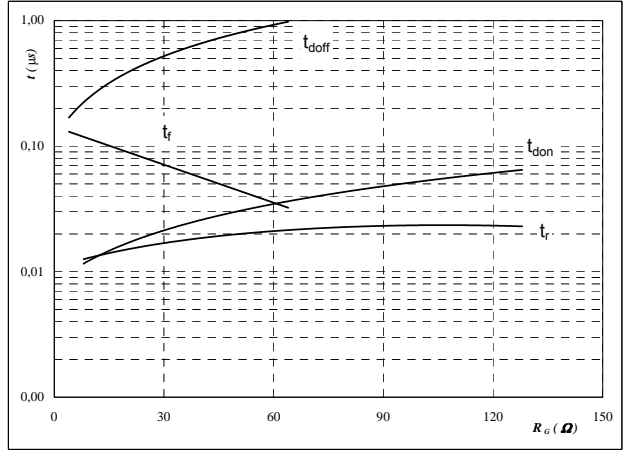


With an inductive load at
 $T_j = 25/125 \text{ } ^\circ\text{C}$
 $V_{CE} = 300 \text{ V}$
 $V_{GE} = 15 \text{ V}$
 $R_{gon} = 16 \text{ } \Omega$
 $R_{goff} = 8 \text{ } \Omega$

Figure 10 Brake IGBT

Typical switching times as a function of gate resistor

$t = f(R_G)$

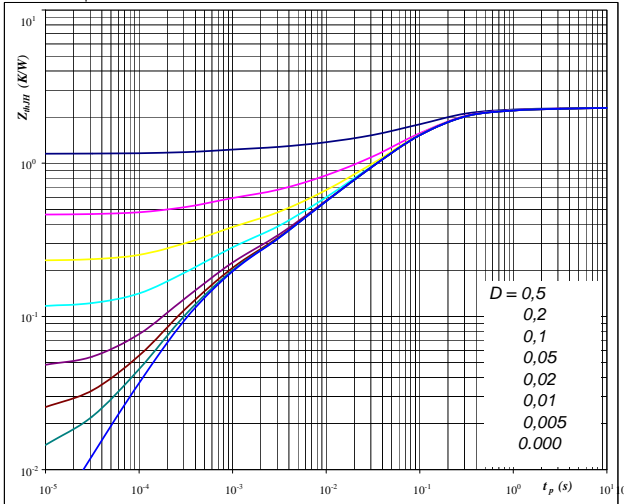


With an inductive load at
 $T_j = 25/125 \text{ } ^\circ\text{C}$
 $V_{CE} = 300 \text{ V}$
 $V_{GE} = 15 \text{ V}$
 $I_C = 20 \text{ A}$

Figure 11 Brake IGBT

IGBT transient thermal impedance as a function of pulse width

$Z_{thJH} = f(t_p)$

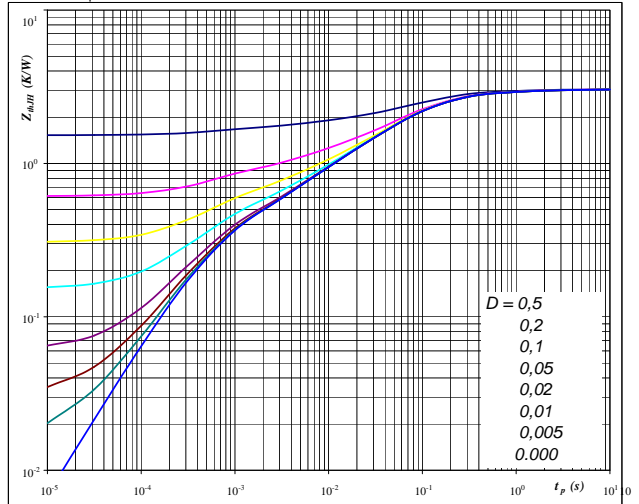


At Thermal grease $R_{thJH} = 2,30 \text{ K/W}$
 D = tp / T
 Phase change interface $R_{thJH} = 0,60 \text{ K/W}$

Figure 12 Brake FWD

FWD transient thermal impedance as a function of pulse width

$Z_{thJH} = f(t_p)$



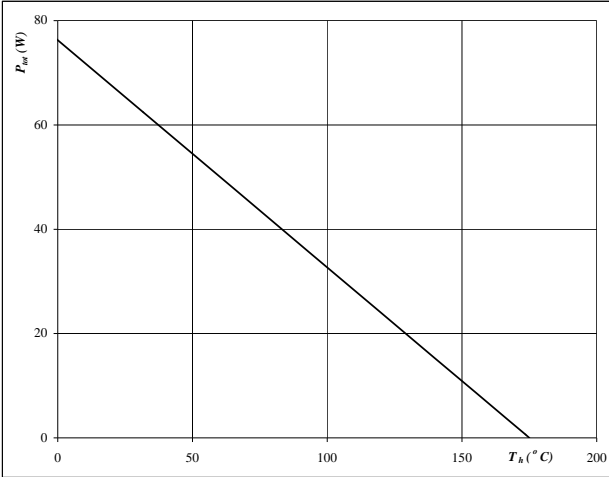
At Thermal grease $R_{thJH} = 3,04 \text{ K/W}$
 D = tp / T
 Phase change interface $R_{thJH} = 1,27 \text{ K/W}$

Brake

Figure 13 Brake IGBT

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_h)$$

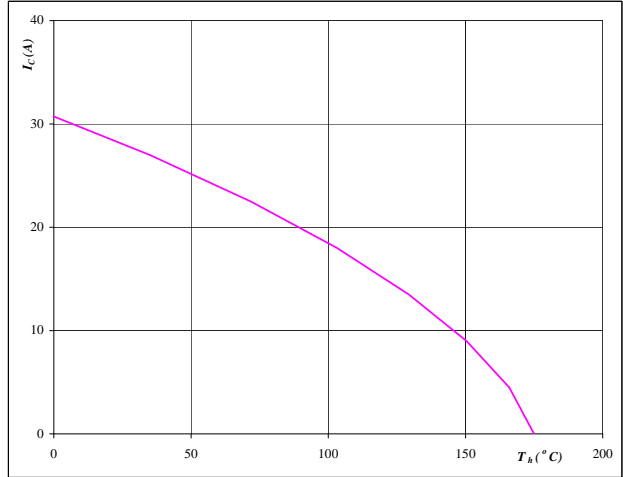


At
 $T_j = 175$ °C

Figure 14 Brake IGBT

Collector current as a function of heatsink temperature

$$I_C = f(T_h)$$

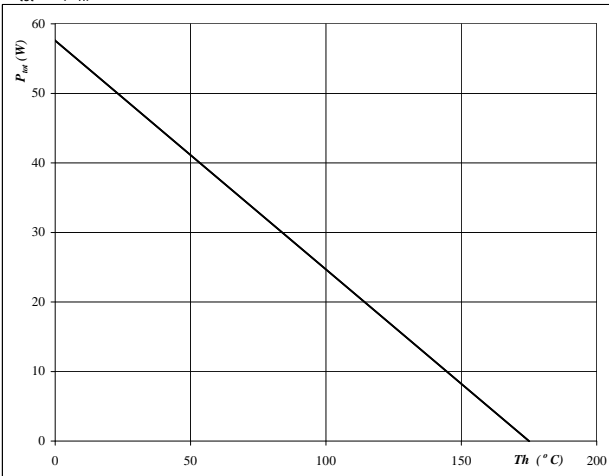


At
 $T_j = 175$ °C
 $V_{GE} = 15$ V

Figure 15 Brake FWD

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_h)$$

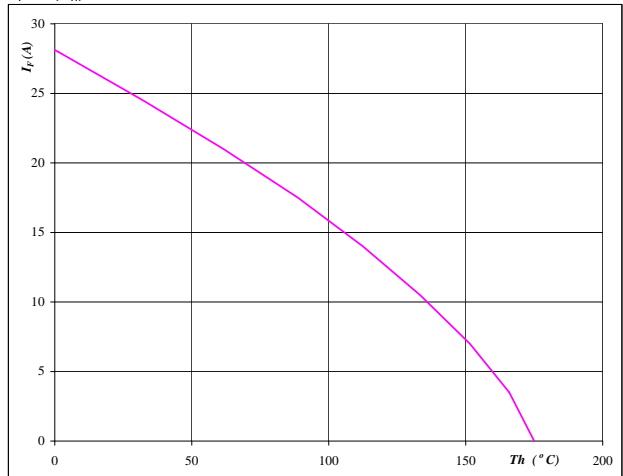


At
 $T_j = 175$ °C

Figure 16 Brake FWD

Forward current as a function of heatsink temperature

$$I_F = f(T_h)$$



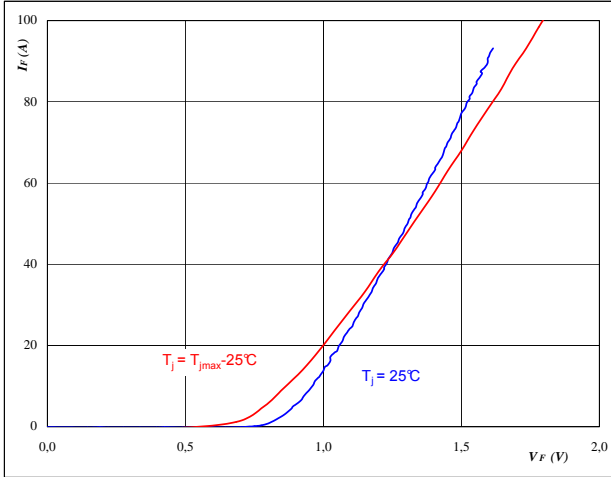
At
 $T_j = 175$ °C

Input Rectifier Bridge

Figure 1 Rectifier diode

Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$

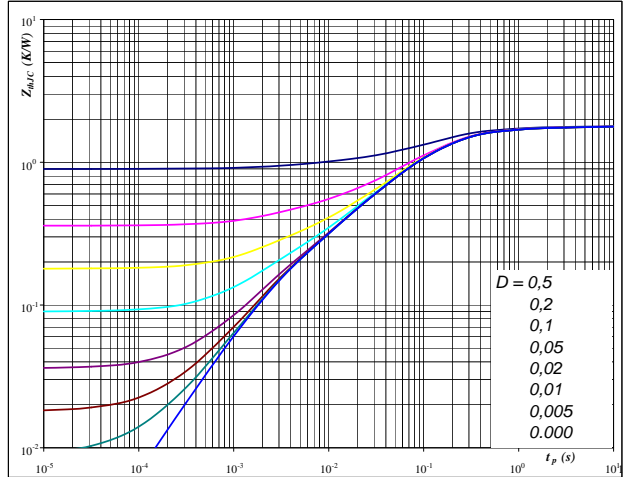


At $t_p = 250 \mu s$

Figure 2 Rectifier diode

Diode transient thermal impedance as a function of pulse width

$Z_{thJH} = f(t_p)$

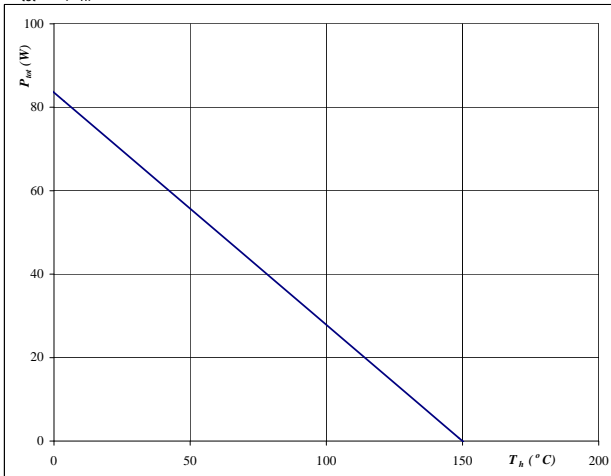


At $D = t_p / T$
 $R_{thJH} = 1,89 \text{ K/W}$

Figure 3 Rectifier diode

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

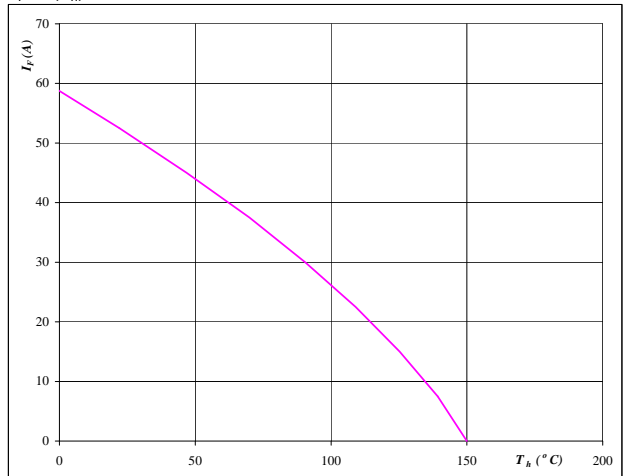


At $T_j = 150 \text{ °C}$

Figure 4 Rectifier diode

Forward current as a function of heatsink temperature

$I_F = f(T_h)$



At $T_j = 150 \text{ °C}$

Thermistor

Figure 1 Thermistor

Typical NTC characteristic
as a function of temperature

$$R_T = f(T)$$

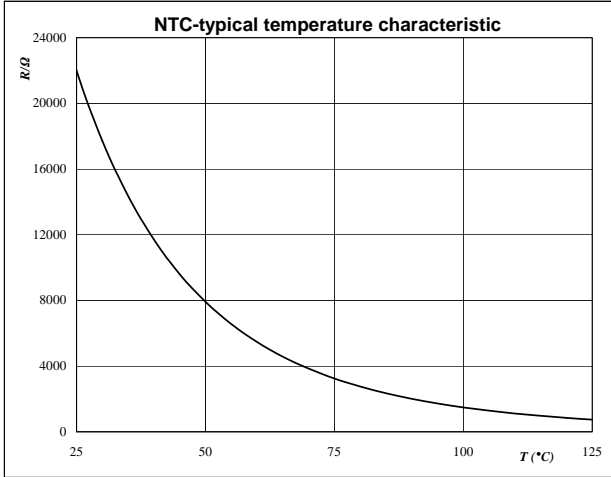


Figure 2 Thermistor

Typical NTC resistance values

$$R(T) = R_{25} \cdot e^{\left(B_{25/100} \left(\frac{1}{T} - \frac{1}{T_{25}} \right) \right)} \quad [\Omega]$$

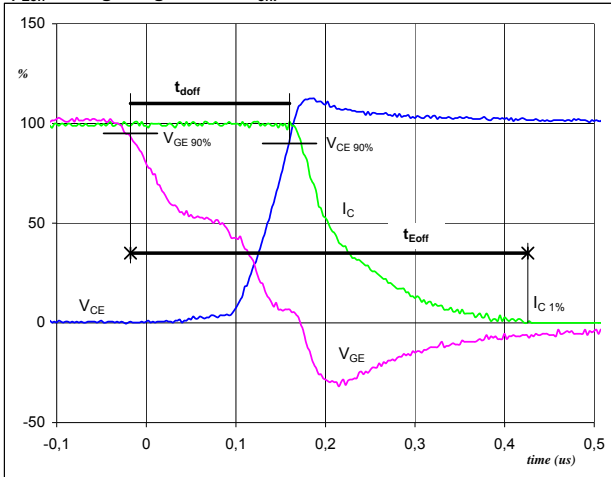
| T [°C] | R _{nom} [Ω] | R _{min} [Ω] | R _{max} [Ω] | ΔR/R [%] |
|------------|----------------------|----------------------|----------------------|----------|
| -55 | 2089434,5 | 1506495,4 | 2672373,6 | 27,9 |
| 0 | 71804,2 | 59724,4 | 83884 | 16,8 |
| 10 | 43780,4 | 37094,4 | 50466,5 | 15,3 |
| 20 | 27484,6 | 23684,6 | 31284,7 | 13,8 |
| 25 | 22000 | 19109,3 | 24890,7 | 13,1 |
| 30 | 17723,3 | 15512,2 | 19934,4 | 12,5 |
| 60 | 5467,9 | 4980,6 | 5955,1 | 8,9 |
| 70 | 3848,6 | 3546 | 4151,1 | 7,9 |
| 80 | 2757,7 | 2568,2 | 2947,1 | 6,9 |
| 90 | 2008,9 | 1889,7 | 2128,2 | 5,9 |
| 100 | 1486,1 | 1411,8 | 1560,4 | 5 |
| 150 | 400,2 | 364,8 | 435,7 | 8,8 |

Switching Definitions Output Inverter

| General conditions | |
|--------------------|---------------|
| T_j | = 125 °C |
| R_{gon} | = 16 Ω |
| R_{goff} | = 8 Ω |

Figure 1 Output inverter IGBT

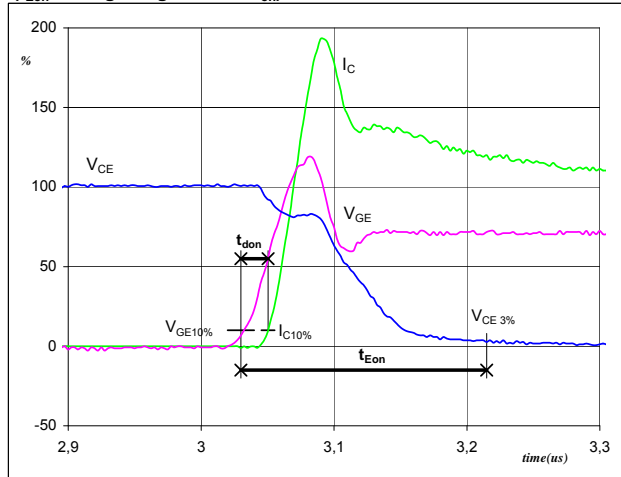
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff}
 (t_{Eoff} = integrating time for E_{off})



| | | |
|-------------------|------|---------|
| $V_{GE}(0\%) =$ | 0 | V |
| $V_{GE}(100\%) =$ | 15 | V |
| $V_C(100\%) =$ | 300 | V |
| $I_C(100\%) =$ | 30 | A |
| $t_{doff} =$ | 0,17 | μs |
| $t_{Eoff} =$ | 0,44 | μs |

Figure 2 Output inverter IGBT

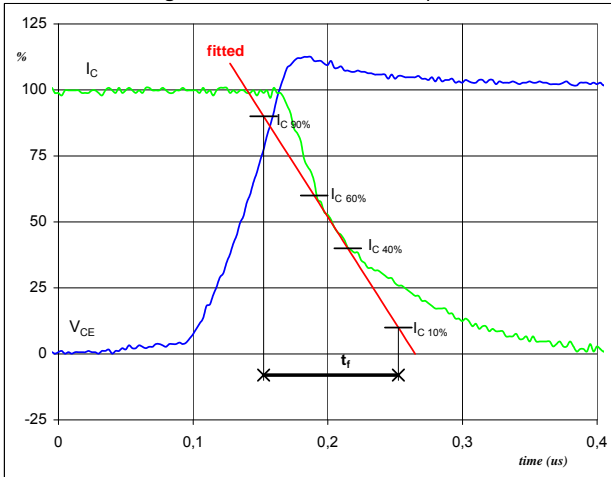
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon}
 (t_{Eon} = integrating time for E_{on})



| | | |
|-------------------|------|---------|
| $V_{GE}(0\%) =$ | 0 | V |
| $V_{GE}(100\%) =$ | 15 | V |
| $V_C(100\%) =$ | 300 | V |
| $I_C(100\%) =$ | 30 | A |
| $t_{don} =$ | 0,02 | μs |
| $t_{Eon} =$ | 0,18 | μs |

Figure 3 Output inverter IGBT

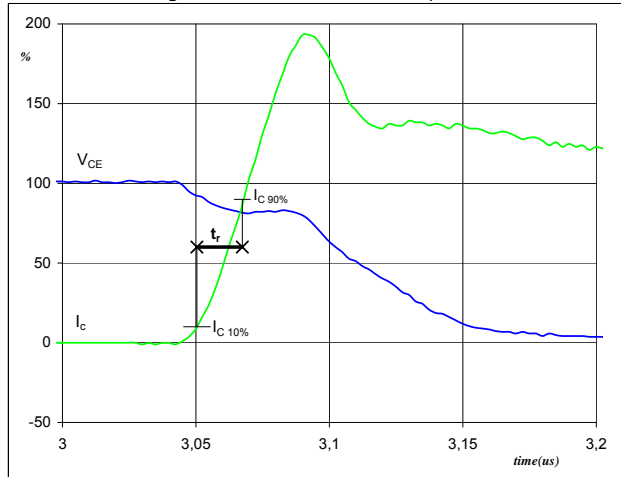
Turn-off Switching Waveforms & definition of t_f



| | | |
|----------------|------|---------|
| $V_C(100\%) =$ | 300 | V |
| $I_C(100\%) =$ | 30 | A |
| $t_f =$ | 0,10 | μs |

Figure 4 Output inverter IGBT

Turn-on Switching Waveforms & definition of t_r

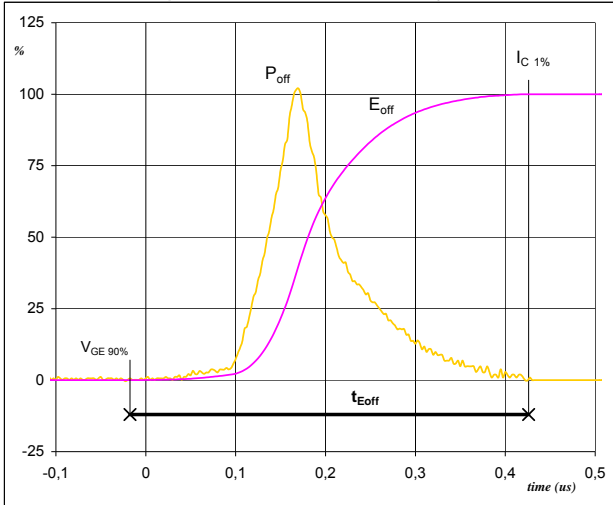


| | | |
|----------------|------|---------|
| $V_C(100\%) =$ | 300 | V |
| $I_C(100\%) =$ | 30 | A |
| $t_r =$ | 0,02 | μs |

Switching Definitions Output Inverter

Figure 5 Output inverter IGBT

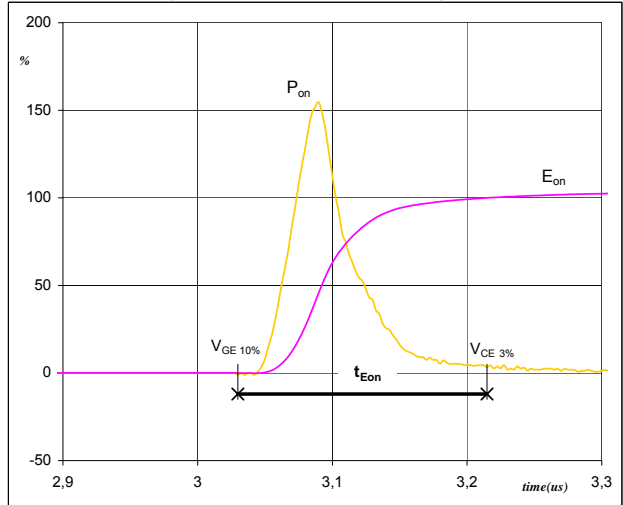
Turn-off Switching Waveforms & definition of t_{Eoff}



$P_{off}(100\%) = 8,98 \text{ kW}$
 $E_{off}(100\%) = 0,90 \text{ mJ}$
 $t_{Eoff} = 0,44 \text{ }\mu\text{s}$

Figure 6 Output inverter IGBT

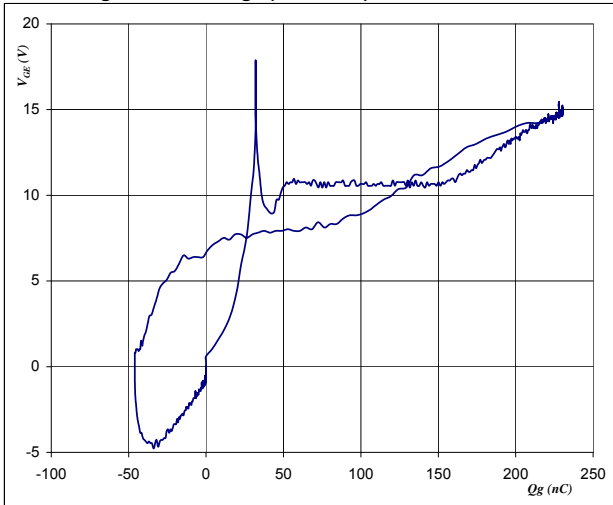
Turn-on Switching Waveforms & definition of t_{Eon}



$P_{on}(100\%) = 8,98 \text{ kW}$
 $E_{on}(100\%) = 0,71 \text{ mJ}$
 $t_{Eon} = 0,18 \text{ }\mu\text{s}$

Figure 7 Output inverter FWD

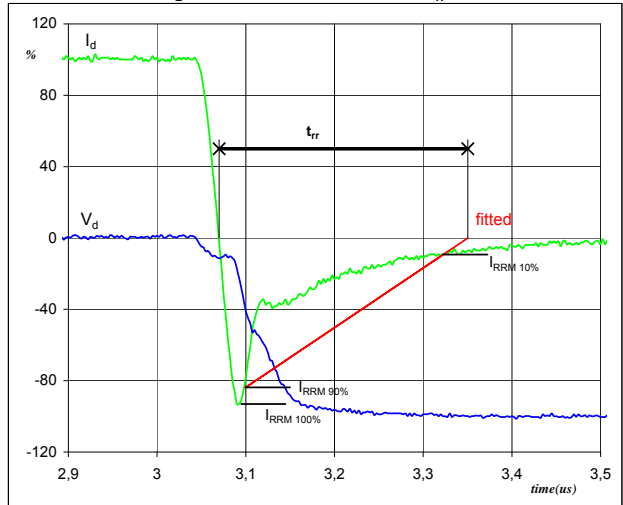
Gate voltage vs Gate charge (measured)



$V_{GEoff} = 0 \text{ V}$
 $V_{GEon} = 15 \text{ V}$
 $V_C(100\%) = 300 \text{ V}$
 $I_C(100\%) = 30 \text{ A}$
 $Q_g = 230,15 \text{ nC}$

Figure 8 Output inverter IGBT

Turn-off Switching Waveforms & definition of t_{rr}

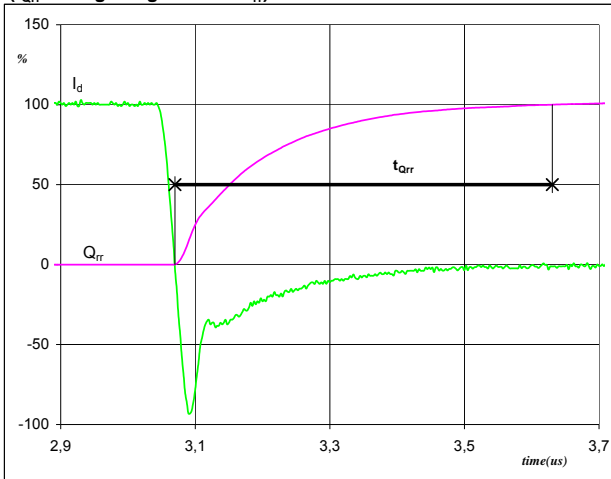


$V_d(100\%) = 300 \text{ V}$
 $I_d(100\%) = 30 \text{ A}$
 $I_{RRM}(100\%) = 28 \text{ A}$
 $t_{rr} = 0,26 \text{ }\mu\text{s}$

Switching Definitions Output Inverter

Figure 9 Output inverter FWD

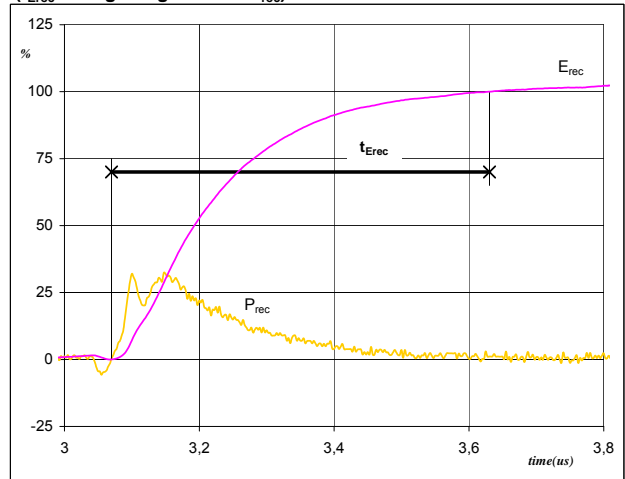
Turn-on Switching Waveforms & definition of t_{Qrr}
 (t_{Qrr} = integrating time for Q_{rr})



| | | |
|-------------------|------|---------------|
| I_d (100%) = | 30 | A |
| Q_{rr} (100%) = | 2,45 | μC |
| t_{Qrr} = | 0,56 | μs |

Figure 10 Output inverter FWD

Turn-on Switching Waveforms & definition of t_{Erec}
 (t_{Erec} = integrating time for E_{rec})



| | | |
|--------------------|------|---------------|
| P_{rec} (100%) = | 8,98 | kW |
| E_{rec} (100%) = | 0,51 | mJ |
| t_{Erec} = | 0,56 | μs |

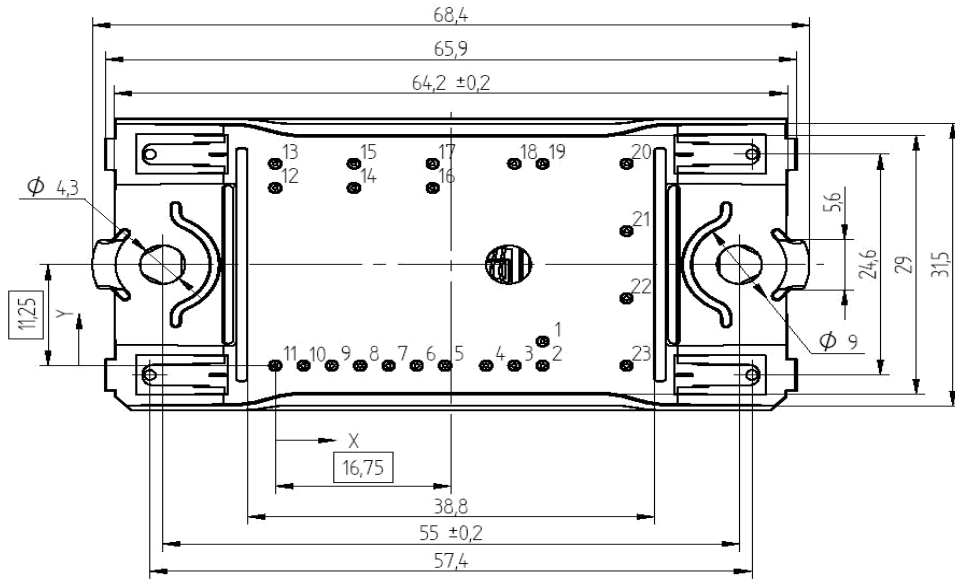
Ordering Code and Marking - Features - Outline - Pinout

Ordering Code & Marking

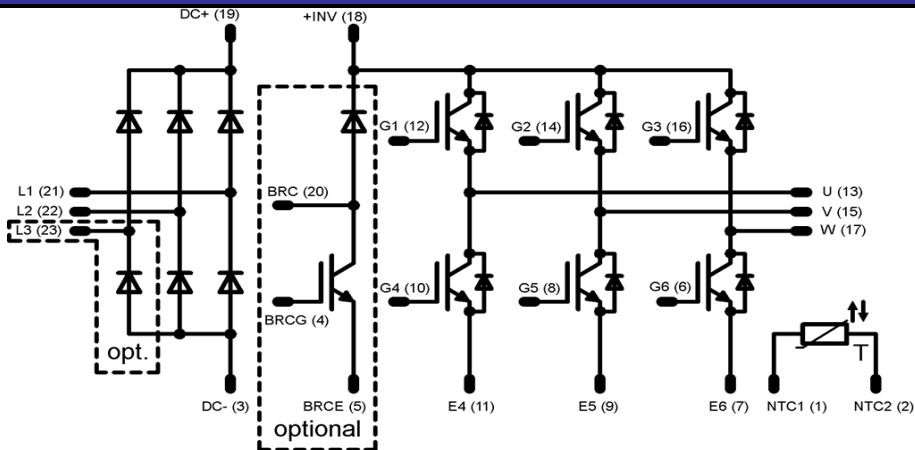
| Version | Ordering Code | in DataMatrix as | in packaging barcode as |
|--|--------------------|------------------|-------------------------|
| without thermal paste 12mm 2 clips housing | V23990-P546-A38-PM | P546-A38 | P546-A38 |
| without thermal paste 17mm 2 clips housing | V23990-P546-A39-PM | P546-A39 | P546-A39 |
| without thermal paste 12mm 2 clips housing | V23990-P546-C38-PM | P546-C38 | P546-C38 |
| without thermal paste 17mm 2 clips housing | V23990-P546-C39-PM | P546-C39 | P546-C39 |

Outline

| Pin Table | | |
|-----------|------|------|
| Pin | X | Y |
| 1 | 25.5 | 2.7 |
| 2 | 25.5 | 0 |
| 3 | 22.8 | 0 |
| 4 | 20.1 | 0 |
| 5 | 16.2 | 0 |
| 6 | 13.5 | 0 |
| 7 | 10.8 | 0 |
| 8 | 8.1 | 0 |
| 9 | 5.4 | 0 |
| 10 | 2.7 | 0 |
| 11 | 0 | 0 |
| 12 | 0 | 19.8 |
| 13 | 0 | 22.5 |
| 14 | 7.5 | 19.8 |
| 15 | 7.5 | 22.5 |
| 16 | 15 | 19.8 |
| 17 | 15 | 22.5 |
| 18 | 22.8 | 22.5 |
| 19 | 25.5 | 22.5 |
| 20 | 33.5 | 22.5 |
| 21 | 33.5 | 15 |
| 22 | 33.5 | 7.5 |
| 23 | 33.5 | 0 |



Pinout



DISCLAIMER

The information given in this datasheet describes the type of component and does not represent assured characteristics. For tested values please contact Vincotech. Vincotech reserves the right to make changes without further notice to any products herein to improve reliability, function or design. Vincotech does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under its patent rights, nor the rights of others.

LIFE SUPPORT POLICY

Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.